



# MP9N150

## 主要参数 MAIN CHARACTERISTICS

ID	9 A
VDSS	1500 V
Rdson-max	2.50Ω
Qg-typ	87.9 nC

## 用途

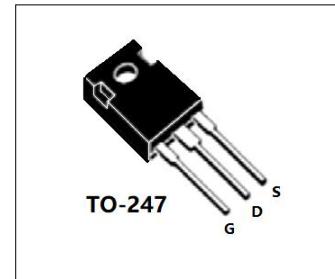
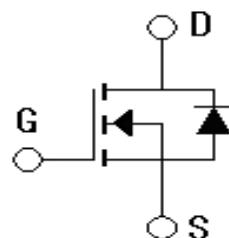
- 高频开关电源
- 电子镇流器
- UPS 电源
- High efficiency switch mode power supplies
- Electronic lamp ballasts based on half bridge
- UPS

## 产品特性

- 低栅极电荷
- 低  $C_{rss}$  (典型值 10 pF)
- 开关速度快
- 产品全部经过雪崩测试
- 高抗 dv/dt 能力
- RoHS 产品
- Low gate charge
- Low  $C_{rss}$  (typical 10 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS product

## FEATURES

## 封装 Package



## 订货信息 ORDER MESSAGE

订货型号 Order codes				印记 Marking	封装 Package
有卤-条管 Halogen-Tube	无卤-条管 Halogen-Free-Tube	有卤-编带 Halogen-Reel	无卤-编带 Halogen-Free-Reel		
MP9N150-GE-B	MP9N150-GE-BR	N/A	N/A	MP9N150	TO-247



MP9N150

绝对最大额定值 ABSOLUTE RATINGS ( $T_c=25^\circ\text{C}$ )

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
		MP9N150	
最高漏极—源极直流电压 Drain-Source Voltage	$V_{DSS}$	1500	V
连续漏极电流 Drain Current -continuous	$I_D$ $T=25^\circ\text{C}$ $T=100^\circ\text{C}$	9*	A
		5*	A
最大脉冲漏极电流 (注 1) Drain Current -pulse (note 1)	$I_{DM}$	36*	A
最高栅源电压 Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	$E_{AS}$	121.5	mJ
雪崩电流 (注 1) Avalanche Current (note 1)	$I_{AR}$	9	A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	$E_{AR}$	52.7	mJ
二极管反向恢复最大电压变化速 率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0	V/ns
耗散功率 Power Dissipation	$P_D$ $T_c=25^\circ\text{C}$ -Derate above $25^\circ\text{C}$	370	W
		2.96	W/ $^\circ\text{C}$
最高结温及存储温度 Operating and Storage Temperature Range	$T_J$ , $T_{STG}$	-55~+150	$^\circ\text{C}$
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	$T_L$	300	$^\circ\text{C}$

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature



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## 电特性 ELECTRICAL CHARACTERISTIC

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
<b>关态特性 Off -Characteristics</b>						
漏一源击穿电压 Drain-Source Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	1500	-	-	V
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=1500V, V_{GS}=0V, T_c=25^\circ C$	-	-	10	$\mu A$
		$V_{DS}=1200V, T_c=125^\circ C$	-	-	10	$\mu A$
正向栅极体漏电流 Gate-body leakage current, forward	$I_{GSSF}$	$V_{DS}=0V, V_{GS} =30V$	-	-	100	nA
反向栅极体漏电流 Gate-body leakage current, reverse	$I_{GSSR}$	$V_{DS}=0V, V_{GS} =-30V$	-	-	-100	nA
<b>通态特性 On-Characteristics</b>						
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D=250\mu A$	3.0	-	5.0	V
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} =10V, I_D=4.5A$	-	2.0	2.5	$m\Omega$
正向跨导 Forward Transconductance	$g_{fs}$	$V_{DS} = 40V, I_D=9A$ (note 4)	-	25.1	-	S
<b>动态特性 Dynamic Characteristics</b>						
输入电容 Input capacitance	$C_{iss}$	$V_{DS}=25V,$ $V_{GS} =0V,$ $f=1.0MHz$	-	4943	7414	pF
输出电容 Output capacitance	$C_{oss}$		-	298	447	pF
反向传输电容 Reverse transfer capacitance	$C_{rss}$		-	10	15	pF



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## 电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
<b>开关特性 Switching –Characteristics</b>						
延迟时间 Turn-On delay time	$t_{d(on)}$	$V_{DD}=750V,$ $I_D=9A,$ $R_G=25\Omega$ (note 4, 5)	-	84.8	127.2	ns
上升时间 Turn-On rise time	$t_r$		-	61	91.5	ns
延迟时间 Turn-Off delay time	$t_{d(off)}$		-	193.8	290.7	ns
下降时间 Turn-Off Fall time	$t_f$		-	60	90	ns
栅极电荷总量 Total Gate Charge	$Q_g$	$V_{ds}=750V,$	-	87.9	131.9	nC
栅一源电荷 Gate-Source charge	$Q_{gs}$	$V_{gs}=10V,$	-	34.5	-	nC
栅一漏电荷 Gate-Drain charge	$Q_{gd}$	$I_d=9A$ (note 4, 5)	-	23.34	-	nC
<b>漏一源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings</b>						
正向最大连续电流 Maximum Continuous Drain-Source Diode Forward Current		$I_S$	-	-	9	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current		$I_{SM}$	-	-	36	A
正向压降 Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=9A$	-	-	1.4	V
反向恢复时间 Reverse recovery time	$t_{rr}$	$V_{GS}=0V, I_S=9A$	-	485.3	-	ns
反向恢复电荷 Reverse recovery charge	$Q_{rr}$	$dI_F/dt=100A/\mu s$ (note 4)	-	5398	-	nC

## 热特性 THERMAL CHARACTERISTIC

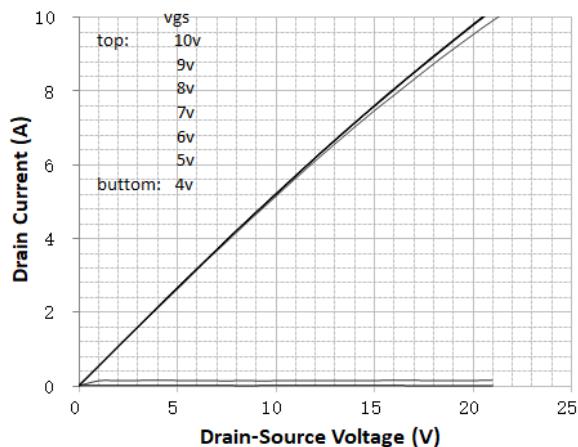
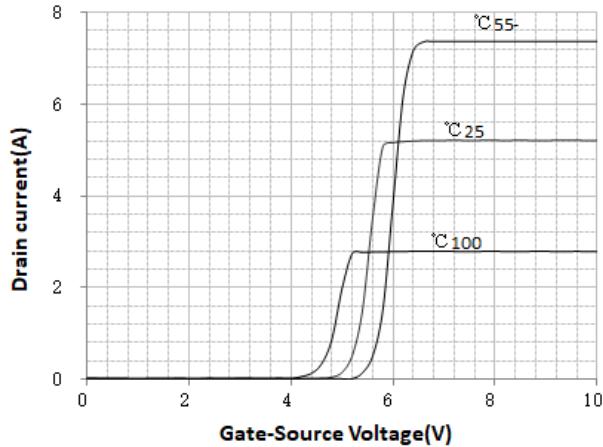
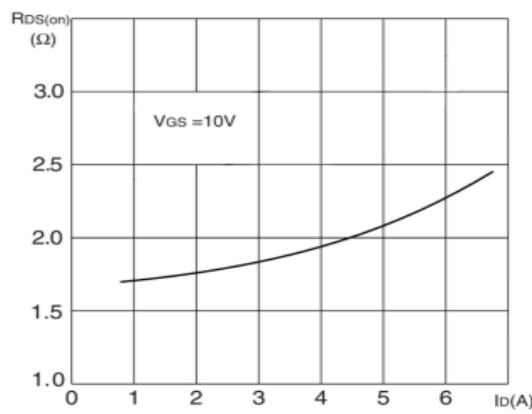
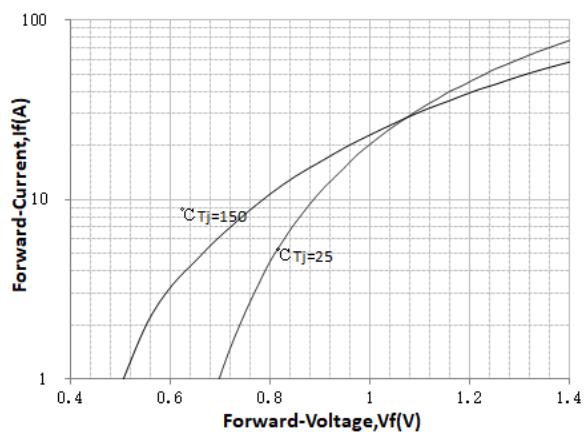
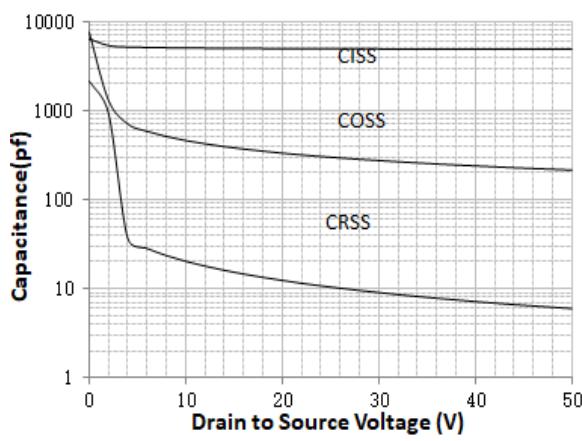
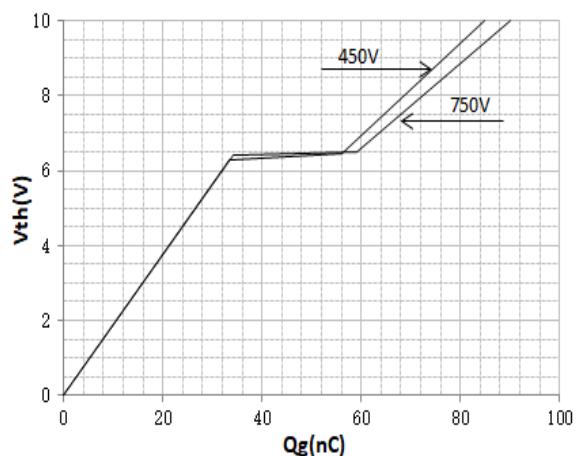
项目 Parameter	符号 Symbol	最大值 Value		单位 Unit
		MP9N150		
结到管壳的热阻 Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.169		°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	62.5		°C/W

注:

- 1: 脉冲宽度由最高结温限制
- 2:  $L=3.0mH, I_{AS}=9A, V_{DD}=50V, R_G=25\Omega$ , 起始结温  $T_J=25^\circ C$
- 3:  $I_{SD} \leq 9A, dI/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS}$ , 起始结温  $T_J=25^\circ C$
- 4: 脉冲测试: 脉冲宽度  $\leq 300\mu s$ , 占空比  $\leq 2\%$
- 5: 基本与工作温度无关

Notes:

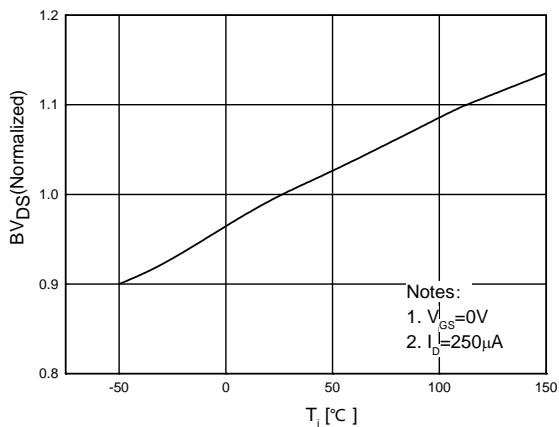
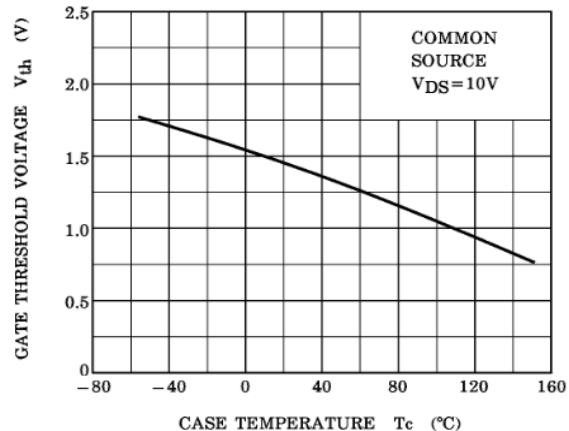
- 1: Pulse width limited by maximum junction temperature
- 2:  $L=3.0mH, I_{AS}=9A, V_{DD}=50V, R_G=25\Omega$ , Starting  $T_J=25^\circ C$
- 3:  $I_{SD} \leq 9A, dI/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ C$
- 4: Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$
- 5: Essentially independent of operating temperature

**特征曲线 ELECTRICAL CHARACTERISTICS (curves)**
**On-Region Characteristics**

**Transfer Characteristics**

**On-Resistance Variation vs Drain Current and Gate Voltage**

**Body Diode Forward Voltage Variation vs. Source Current and Temperature**

**Capacitance Characteristics**

**Gate Charge Characteristics**


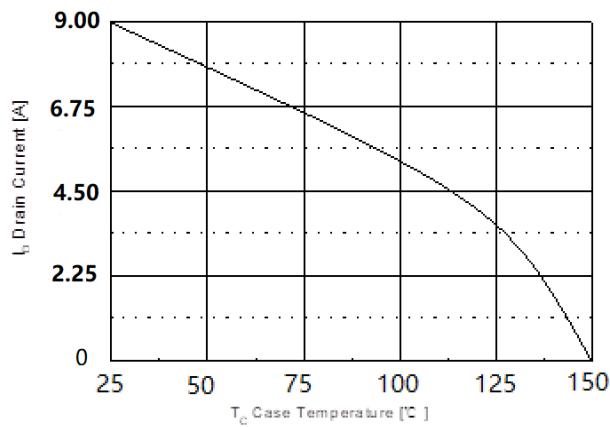


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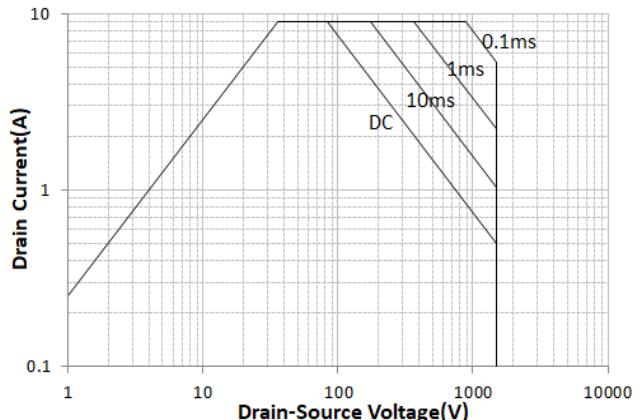
## 特征曲线 ELECTRICAL CHARACTERISTICS (curves)

Breakdown Voltage Variation  
vs. TemperatureGate Threshold Voltage  
vs. Case Temperature

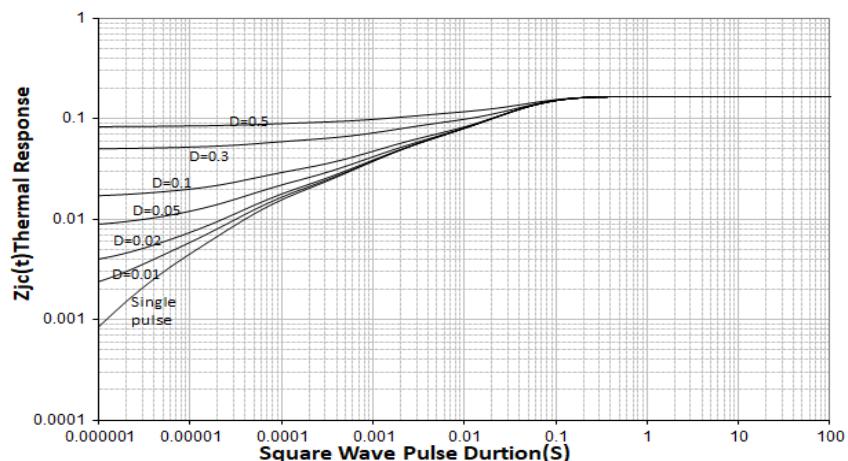
## Maximum Drain Current vs. Case Temperature



## Maximum Safe Operating Area



## Transient Thermal Response Curve

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JILIN SINO-MICROELECTRONICS CO.,LTD

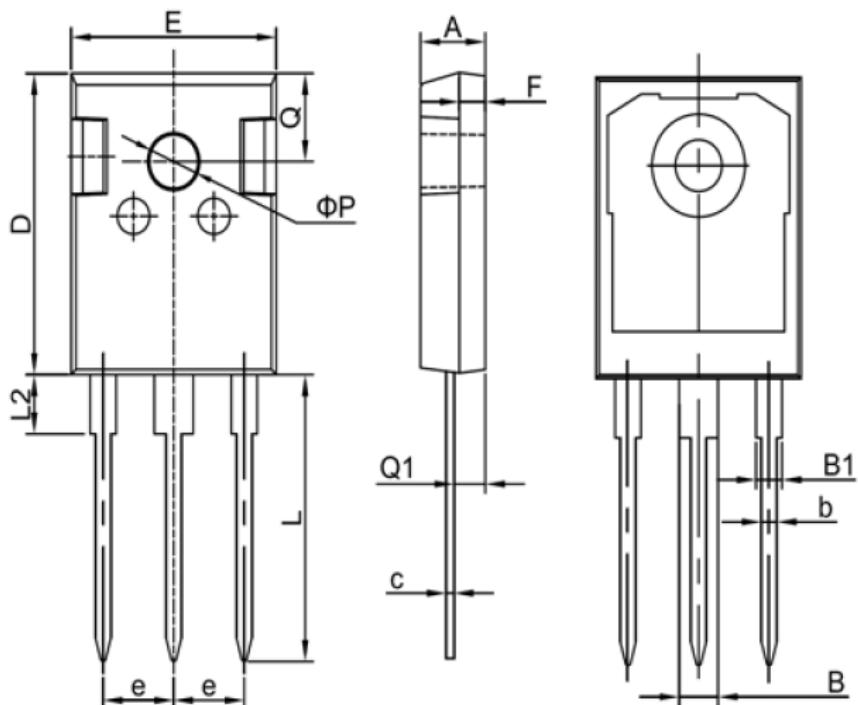


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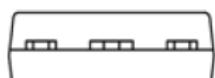
## 外形尺寸 PACKAGE MECHANICAL DATA

TO-247

单位 Unit: mm



符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70





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2. We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
4. Jilin Sino-microelectronics co., Ltd reserves the right to make changes in this. specification sheet and is subject to change without prior notice.

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